



# **PRODUCT DATASHEET**



► Warm White 3000K





N0W64S02

# **APPLICATIONS:**

- **General Lighting** •
- **Portable Lighting**
- **Commercial Lighting** •
- Indoor Lighting •
- Backlight for LCD •

# **4014 EMC Series**



# **FEATURES:**

- Package: Top View PLCC2 White Package
- Forward Current: 60mA
- Forward Voltage (typ.): 2.8V
- Luminous Flux (typ.): 30lm@60mA •
- Colour: Warm White .
- Colour Temperature (CCT): 3000K
- Viewing angle: 120° •
  - Materials:

.

- Die: InGaN \_
- Resin: Silicon (Yellow Diffused) \_ \_ Package: PLCC
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+85°C
- Electrostatics Discharge: 1000V
  - **Grouping parameters:** 
    - **Forward Voltage** \_
    - \_ Luminous Flux
  - **CIE Chromaticity** \_
- Soldering methods: Reflow Soldering MSL Level: MSL3 according to J-STD020
- Packing: 12mm tape with max.4000/reel, ø178mm (7")





# CHARACTERISTICS:

## Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	lf	90	mA
Pulse Forward Current (Duty 1/10, width≤100µS)	Ipf	120	mA
Power Dissipation	PD	270	mW
Reverse Voltage	V <sub>R</sub>	5	V
Reverse Current @10V	IR	10	μΑ
Junction Temperature	Tj	105	°C
Electrostatic Discharge	ESD	1000	V
Thermal Resistance (Junction to Solder Point)	Rтнлs	16	°C/W
Operating Temperature	T <sub>OPR</sub>	-40~+85	°C
Storage Temperature	Тѕтб	-40~+85	°C
Soldering Temperature	T <sub>SOL</sub>	245 for 10S	°C
Colour Rendering Index	CRI	80	

## Electrical & Optical Characteristics (Ta=25°C, RH=60%)

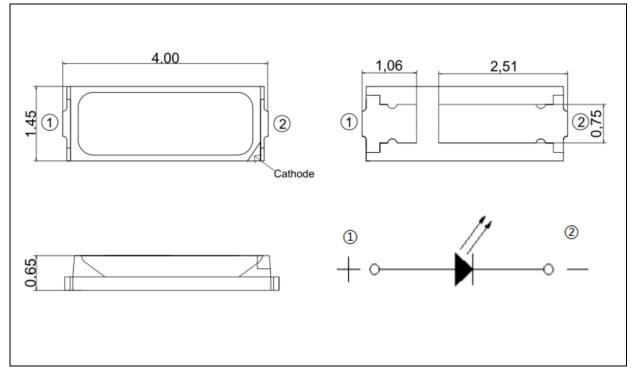
Parameter	Symbol Values				Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition	
Forward Voltage	VF	2.6	2.8	3.0	V	I⊧=60mA	
Luminous Flux	Φv	28	30	34	lm	I⊧=60mA	
Chromaticity	х		0.4342				
Coordinates	Y		0.4028			I <sub>F</sub> =60mA	
Colour Temperature	ССТ		3000		К	I⊧=60mA	
Viewing Angle	2 <b>θ</b> 1/2		120		deg	I⊧=60mA	

1. Luminous flux ( $\Phi_V$ ) ±10%, Forward Voltage (V<sub>F</sub>) ±0.1V, CRI ±2



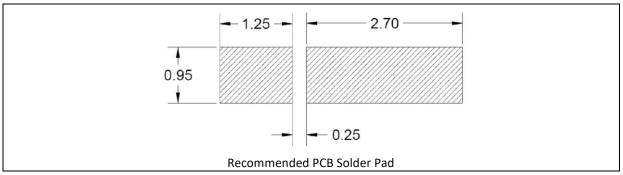
# **OUTLINE DIMENSION:**

## Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

## Recommended Soldering Pad Dimension:



1. Dimensions are in millimetre (mm).

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2. Tolerance  $\pm 0.1$ mm with angle tolerance  $\pm 0.5^{\circ}$ .



## **BINNING GROUPS:**

## Forward Voltage Classifications (I<sub>F</sub> = 60mA):

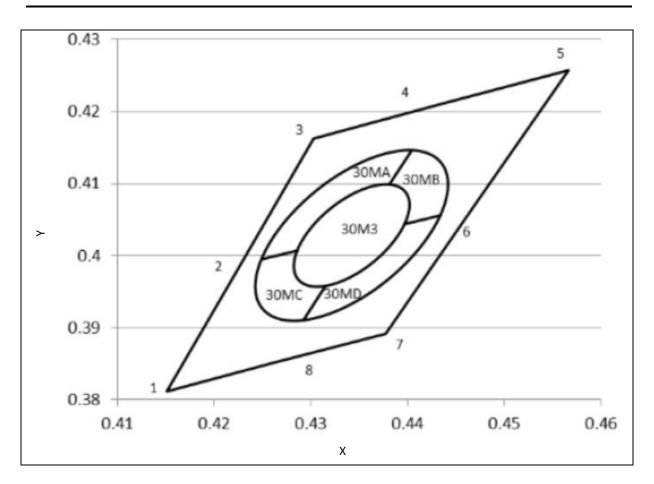
Code	Min.	Max.	Unit
Z1	2.6	2.7	
A1	2.7	2.8	V
B1	2.8	2.9	v
C1	2.9	3.0	

## Luminous Flux Classifications (I<sub>F</sub> = 60mA):

Code	Min.	Max.	Unit
D7	28	30	
D8	30	32	lm
D9	32	34	



**CIE CHROMATICITY DIAGRAM:** 



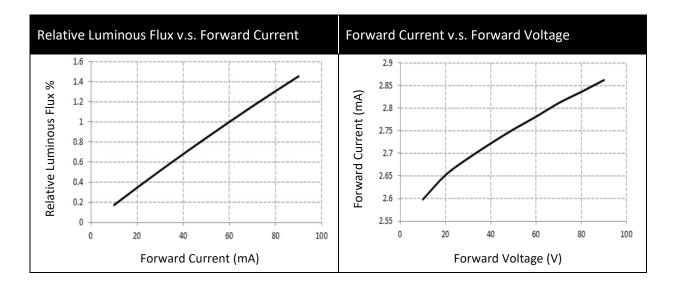
## Chromaticity Coordinates Classifications (I<sub>F</sub> = 60mA):

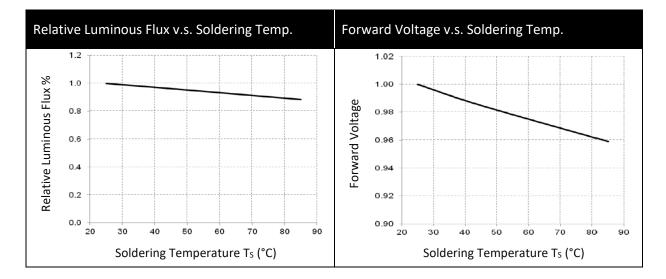
	Cada	Centre		Radius		Angle	
a	Code	Х	Y	а	b	Φ	
D D D	30M5	0.4342	0.4028	0.002780	0.001360	53.13	

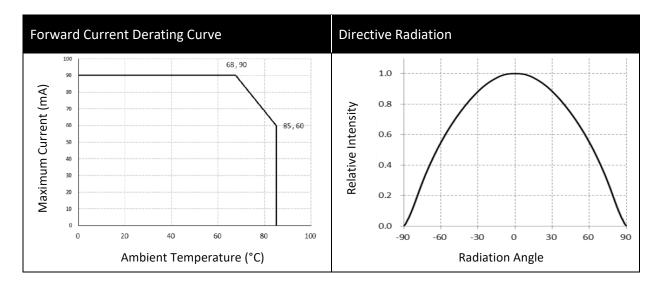
	1	1	E	3		5		7
	Х	Y	Х	Y	Х	Y	Х	Y
3000K	0.4151	0.3812	0.4303	0.4163	0.4566	0.4258	0.4377	0.3891



# **ELECTRO-OPTICAL CHARACTERISTICS:**

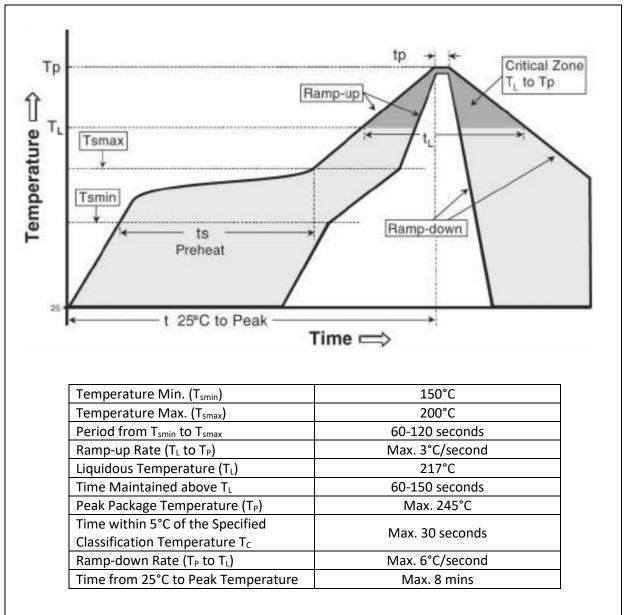








## **RECOMMENDED SOLDERING PROFILE:**



Reflow Lead-free Solder:

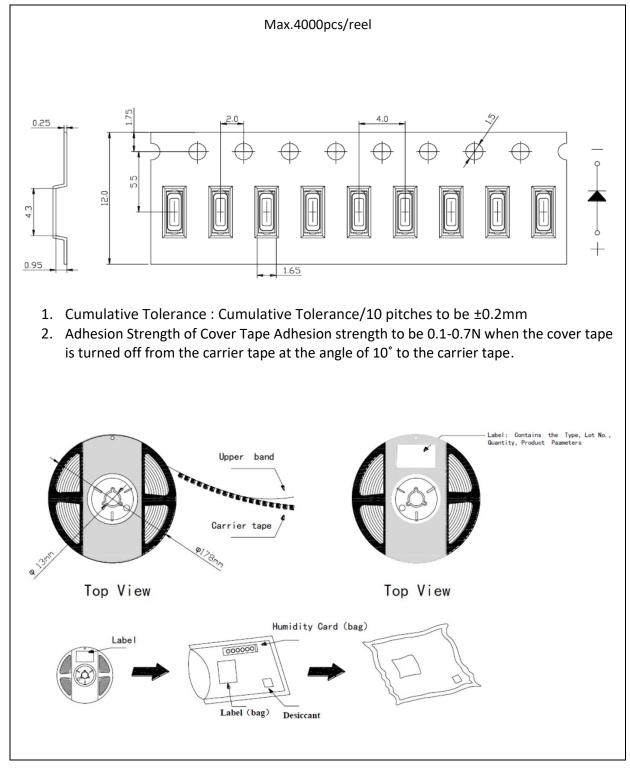
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 245°C for max. 10seconds.



# **PACKING SPECIFICATION:**

## Reel Dimension:



## **PRECAUTIONS OF USE:**



### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	01/02/2023	Datasheet set-up.